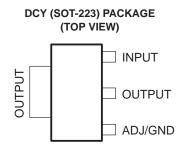
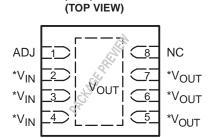
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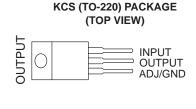
- 1.5 V, 1.8 V, 2.5 V, 2.85 V, 3.3 V, 5 V, and Adjustable Output Voltage Options
- Output Current of 800 mA
- Operates Down to 1.1-V Dropout

- Specified Dropout Voltage at Multiple Current Levels
- 0.2% Line Regulation Maximum
- 0.4% Load Regulation Maximum
- Max V_{IN} of 15 V



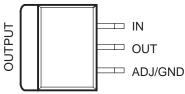


DRJ (QFN) PACKAGE

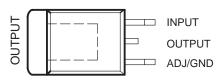


*V_{IN} pins (2, 3, 4) must be connected together; V_{OUT} pins (5, 6, 7) must be connected together.

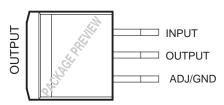
KTE (PowerFLEX™) PACKAGE (TOP VIEW)



KTP (PowerFLEX™/TO-252) PACKAGE (TOP VIEW)



KTT (TO-263) PACKAGE (TOP VIEW)



description/ordering information

The TLV1117 is a positive low-dropout voltage regulator, designed to provide up to 800 mA of output current. The device is available in 1.5 V, 1.8 V, 2.5 V, 2.85 V, 3.3 V, 5 V, and adjustable output voltage options. All internal circuitry is designed to operate down to 1 V input-to-output differential. Dropout voltage is specified at a maximum of 1.3 V at 800 mA, decreasing at lower load currents.

The low-profile surface-mount KTP package allows the device to be used in applications where space is limited. The TLV1117 requires a minimum of 10 μ F of output capacitance for stability. Output capacitors of this size or larger normally are included in most regulator designs.

Unlike pnp-type regulators, where up to 10% of the output current is wasted as quiescent current, the quiescent current of the TLV1117 flows into the load, increasing efficiency.

The TLV1117C device is characterized for operation over the virtual junction temperature range of 0°C to 125°C, and the TLV1117I device is characterized for operation over the virtual junction temperature range of –40°C to 125°C.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PowerFLEX is a trademark of Texas Instruments.



description/ordering information (continued)

TLV1117C ORDERING INFORMATION

TJ	V _O TYP (V)	PACKAGE [†]		ORDERABLE PART NUMBER	TOP-SIDE MARKING
		PowerFLEX (KTE)	Reel of 2000	TLV1117-15CKTER	
		PowerFLEX/TO-252* (KTP)	Reel of 2000	TLV1117-15CKTPR	
		QFN (DRJ)	Reel of 1000	TLV1117-15CDRJR	
	1,5,,	00T 000 (D0) (Tube of 80	TLV1117-15CDCY	
	1.5 V	SOT-223 (DCY)	Reel of 2500	TLV1117-15CDCYR	
		TO-220 (KCS)	Tube of 50	TLV1117-15CKCS	
			Tube of	TLV1117-15CKTT	
		TO-263 (KTT)	Reel of	TLV1117-15CKTTR	
		PowerFLEX (KTE)	Reel of 2000	TLV1117-18CKTER	
		PowerFLEX/TO-252* (KTP)	Reel of 2000	TLV1117-18CKTPR	
		QFN (DRJ)	Reel of 1000	TLV1117-18CDRJR	
l			Tube of 80	TLV1117-18CDCY	
	1.8 V	SOT-223 (DCY)	Reel of 2500	TLV1117-18CDCYR	111
		TO-220 (KCS)	Tube of 50	TLV1117-18CKCS	
			Tube of	TLV1117-18CKTT	
		TO-263 (KTT)	Reel of	TLV1117-18CKTTR	
		PowerFLEX (KTE)	Reel of 2000	TLV1117-25CKTER	
		PowerFLEX/TO-252* (KTP)	Reel of 2000	TLV1117-25CKTPR	
		QFN (DRJ)	Reel of 1000	TLV1117-25CDRJR	
		SOT-223 (DCY)	Tube of 80	TLV1117-25CDCY	
0°C to 125°C	2.5 V		Reel of 2500	TLV1117-25CDCYR	711
		TO-220 (KCS)	Tube of 50	TLV1117-25CKCS	
		TO-263 (KTT)	Tube of	TLV1117-25CKTT	
			Reel of	TLV1117-25CKTTR	
		PowerFLEX (KTE)	Reel of 2000	TLV1117-285CKTER	
		PowerFLEX/TO-252* (KTP)	Reel of 2000	TLV1117-285CKTPR	
		QFN (DRJ)	Reel of 1000	TLV1117-285CDRJR	
			Tube of 80	TLV1117-285CDCY	
	2.85 V	SOT-223 (DCY)	Reel of 2500	TLV1117-285CDCYR	
		TO-220 (KCS)	Tube of 50	TLV1117-285CKCS	
			Tube of	TLV1117-285CKTT	
		TO-263 (KTT)	Reel of	TLV1117-285CKTTR	
		PowerFLEX (KTE)	Reel of 2000	TLV1117-33CKTER	
		PowerFLEX/TO-252* (KTP)	Reel of 2000	TLV1117-33CKTPR	
		QFN (DRJ)	Reel of 1000	TLV1117-33CDRJR	
			Tube of 80	TLV1117-33CDCY	
	3.3 V	SOT-223 (DCY)	Reel of 2500	TLV1117-33CDCYR	
		TO-220 (KCS)	Tube of 50	TLV1117-33CKCS	
		, , ,	Tube of	TLV1117-33CKTT	
		TO-263 (KTT)	Reel of	TLV1117-33CKTTR	

^{*}Complies with TO-252, variation AC.

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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TLV1117C ORDERING INFORMATION (continued)

TJ	V _O TYP (V)	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
		PowerFLEX (KTE)	Reel of 2000	TLV1117-50CKTER	PREVIEW
		PowerFLEX/TO-252* (KTP)	Reel of 2000	TLV1117-50CKTPR	PREVIEW
		QFN (DRJ)	Reel of 1000	TLV1117-50CDRJR	PREVIEW
	5.V	COT 202 (DOV)	Tube of 80	TLV1117-50CDCY	PREVIEW
	5 V	SOT-223 (DCY)	Reel of 2500	TLV1117-50CDCYR	111211211
		TO-220 (KCS)	Tube of 50	TLV1117-50CKCS	PREVIEW
		TO-263 (KTT)	Tube of	TLV1117-50CKTT	PREVIEW
000 1- 40500			Reel of	TLV1117-50CKTTR	PREVIEW
0°C to 125°C		PowerFLEX (KTE)	Reel of 2000	TLV1117CKTER	TLV1117C
		PowerFLEX/TO-252* (KTP)	Reel of 2000	TLV1117CKTPR	TV1117
		QFN (DRJ)	Reel of 1000	TLV1117CDRJR	PREVIEW
	AD.	COT 202 (DOV)	Tube of 80	TLV1117CDCY	1/4
	ADJ	SOT-223 (DCY)	Reel of 2500	TLV1117CDCYR	V4
		TO-220 (KCS)	Tube of 50	TLV1117CKCS	TLV1117C
		TO 202 (I/TT)	Tube of	TLV1117CKTT	PREVIEW
		TO-263 (KTT) Reel of		TLV1117CKTTR	I I/F AIF AA

^{*}Complies with TO-252, variation AC.



[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

TLV1117I ORDERING INFORMATION

ТЈ	V _O TYP (V)	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING			
		PowerFLEX (KTE)	Reel of 2000	TLV1117-15IKTER				
		PowerFLEX/TO-252* (KTP)	Reel of 2000	TLV1117-15IKTPR				
		QFN (DRJ)	Reel of 1000	TLV1117-15IDRJR				
	4.5.4	007.000 (00)	Tube of 80	TLV1117-15IDCY				
	1.5 V	SOT-223 (DCY)	Reel of 2500	TLV1117-15IDCYR				
		TO-220 (KCS)	Tube of 50	TLV1117-15IKCS				
		TO 000 ((/TT)	Tube of	TLV1117-15IKTT				
		TO-263 (KTT)	Reel of	TLV1117-15IKTTR				
		PowerFLEX (KTE)	Reel of 2000	TLV1117-18IKTER				
		PowerFLEX/TO-252* (KTP)	Reel of 2000	TLV1117-18IKTPR				
		QFN (DRJ)	Reel of 1000	TLV1117-18IDRJR				
		007 000 (7.0) (Tube of 80	TLV1117-18IDCY				
–40°C to 125°C	1.8 V	SOT-223 (DCY)	Reel of 2500	TLV1117-18IDCYR				
		TO-220 (KCS)	Tube of 50	TLV1117-18IKCS				
		(()	Tube of	TLV1117-18IKTT				
		TO-263 (KTT)	Reel of	TLV1117-18IKTTR				
		PowerFLEX (KTE)	Reel of 2000	TLV1117-25IKTER				
		PowerFLEX/TO-252* (KTP)	Reel of 2000	TLV1117-25IKTPR				
	2.5 V		QFN (DRJ)	Reel of 1000	TLV1117-25IDRJR			
		SOT-223 (DCY)	Tube of 80	TLV1117-25IDCY				
			Reel of 2500	TLV1117-25IDCYR				
					TO-220 (KCS)	Tube of 50	TLV1117-25IKCS	
		TO-263 (KTT)	Reel of	TLV1117-25IKTTR				
		PowerFLEX (KTE)	Reel of 2000	TLV1117-285IKTER				
		PowerFLEX/TO-252* (KTP)	Reel of 2000	TLV1117-285IKTPR				
		QFN (DRJ)	Reel of 1000	TLV1117-285IDRJR				
4000 / 40500	0.051/	007.000 (00)	Tube of 80	TLV1117-285IDCY				
–40°C to 125°C	2.85 V	SOT-223 (DCY)	Reel of 2500	TLV1117-285IDCYR	LV			
		TO-220 (KCS)	Tube of 50	TLV1117-285IKCS				
		TO 000 (I/TT)	Tube of	TLV1117-285IKTT	,			
		TO-263 (KTT)	Reel of	TLV1117-285IKTTR				
		PowerFLEX (KTE)	Reel of 2000	TLV1117-33IKTER				
		PowerFLEX/TO-252* (KTP)	Reel of 2000	TLV1117-33IKTPR				
		QFN (DRJ)	Reel of 1000	TLV1117-33IDRJR				
4000 4 40500	0.637	SOT-223 (DCY)	Tube of 80	TLV1117-33IDCY				
–40°C to 125°C	3.3 V	SOT-223 (DCY)	Reel of 2500	TLV1117-33IDCYR				
		TO-220 (KCS)	Tube of 50	TLV1117-33IKCS				
		TO 2022 (IVTT)	Tube of	TLV1117-33IKTT				
		TO-263 (KTT)	Reel of	TLV1117-33IKTTR				

^{*}Complies with TO-252, variation AC.



[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

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description/ordering information (continued)

TLV1117I ORDERING INFORMATION (continued)

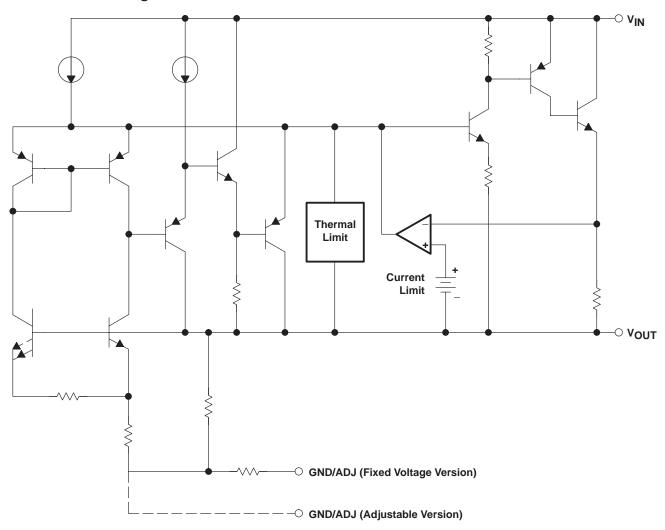
ТЈ	V _O TYP (V)	PACKAGE [†]		ORDERABLE PART NUMBER	TOP-SIDE MARKING
		PowerFLEX (KTE)	Reel of 2000	TLV1117-50IKTER	PREVIEW
		PowerFLEX/TO-252* (KTP)	Reel of 2000	TLV1117-50IKTPR	PREVIEW
		QFN (DRJ)	Reel of 1000	TLV1117-50DRJR	PREVIEW
	5 V	COT 202 (DCV)	Tube of 80	TLV1117-50IDCY	PREVIEW
	5 V	SOT-223 (DCY)	Reel of 2500	TLV1117-50IDCYR	
		TO-220 (KCS)	Tube of 50	TLV1117-50IKCS	PREVIEW
		TO-263 (KTT)	Tube of	TLV1117-50IKTT	PREVIEW
-40°C to 125°C			Reel of	TLV1117-50IKTTR	LIVEAIEAA
-40°C to 125°C		PowerFLEX (KTE)	Reel of 2000	TLV1117IKTER	TLV1117I
		PowerFLEX/TO-252* (KTP)	Reel of 2000	TLV1117IKTPR	TY1117
		QFN (DRJ)	Reel of 1000	TLV1117IDRJR	PREVIEW
	A.D.I.	COT 202 (DCV)	Tube of 80	TLV1117IDCY	V0
	ADJ	SOT-223 (DCY)	Reel of 2500	TLV1117IDCYR	V2
		TO-220 (KCS)	Tube of 50	TLV1117IKCS	TLV1117I
		TO 000 (I/TT)	Tube of	TLV1117IKTT	PREVIEW
		TO-263 (KTT)	Reel of	TLV1117IKTTR	

^{*}Complies with TO-252, variation AC.

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

DEVICE COMPONENT COUNT				
Transistors				
Diodes				
Resistors				
Capacitors				
JFET				
Tunnels (emitter R)				

functional block diagram



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Continuous input voltage	5 V
Operating virtual junction temperature)°C
Storage temperature range, T _{stq} 65°C to 150)°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

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package thermal data (see Note 1)

PACKAGE	BOARD	θ JP *	θЈС	θ JA
PowerFLEX (KTE)	High K, JESD 51-5	2.7°C/W		23°C/W
PowerFLEX/TO-252 (KTP)	High K, JESD 51-5	3°C/W		28°C/W
QFN (DRJ)	High K, JESD 51-5	TBD		TBD
SOT (DCY)	High K, JESD 51-7		4°C/W	53°C/W
TO-263 (KTT)	High K, JESD 51-5	TBD		TBD
TO-220 (KCS)	High K, JESD 51-5	3°C/W		19°C/W

^{*}For packages with exposed thermal pads, such as QFN, PowerPAD, and PowerFLEX, θ_{JP} is defined as the thermal resistance between the die junction and the bottom of the exposed pad.

recommended operating conditions

			MIN†	MAX	UNIT
		TLV1117	2.7	15	
		TLV1117-15	2.9	15	
		TLV1117-18	3.2	15	
VIN Input voltage TLV1117-25 3.9 15 TLV1117-285 4.25 15	V				
		TLV1117-285	7-18 3.2 15 7-25 3.9 15 7-285 4.25 15 7-33 4.7 15 7-50 6.4 15		
		TLV1117-25 3.9 15 V TLV1117-285 4.25 15 TLV1117-33 4.7 15 TLV1117-50 6.4 15			
lout	Output current	•		8.0	Α
_	Or seed to reside a bit of the seed of the	TLV1117C	0	125	
ТЈ	Operating virtual junction temperature range	TLV1117I	-40	2.7 15 2.9 15 3.2 15 3.9 15 .25 15 4.7 15 6.4 15 0.8 0 125	°C

[†] The input-to-output differential across the regulator should provide for some margin against regulator operation at the maximum dropout (for a particular current value). This margin is needed to account for tolerances in both the input voltage (lower limit) and the output voltage (upper limit). The absolute minimum V_{IN} for a desired maximum output current can be calculated by the following:

VIN(min) = VOUT(max) + VDO(max @ rated current)

NOTE 1: Maximum power dissipation is a function of $T_J(max)$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) - T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can affect reliability.

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TLV1117C electrical characteristics, $T_J = 0^{\circ}C$ to 125°C, all typical values are at $T_J = 25^{\circ}C$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS†		MIN	TYP	MAX	UNIT	
	$V_{IN} - V_{OUT} = 2 \text{ V}, I_{OUT} = 10 \text{ mA}, T_{J} = 25^{\circ}\text{C}$	TI \ /4.4.7	1.238	1.250	1.262		
	I_{OUT} = 10 mA to 800 mA, $V_{IN} - V_{OUT}$ = 1.4 V to 10 V	TLV1117	1.225	1.250	1.270		
	$V_{IN} = 3.5 \text{ V}, I_{OUT} = 10 \text{ mA}, T_{J} = 25^{\circ}\text{C}$	TI \ /4447 45	1.485	1.500	1.515		
	$V_{IN} = 2.9 \text{ V to } 10 \text{ V}, I_{OUT} = 0 \text{ to } 800 \text{ mA}$	TLV1117-15	1.470	1.500	1.530		
	$V_{IN} = 3.8 \text{ V}, I_{OUT} = 10 \text{ mA}, T_{J} = 25^{\circ}\text{C}$	TI)/4447.40	1.782	1.800	1.818		
	$V_{IN} = 3.2 \text{ V to } 10 \text{ V}, I_{OUT} = 0 \text{ to } 800 \text{ mA}$	TLV1117-18	1.764	1.800	1.836		
	$V_{IN} = 4.5 \text{ V}, I_{OUT} = 10 \text{ mA}, T_J = 25^{\circ}\text{C}$	TIV 4447 05	2.475	2.500	2.525		
Output voltage, VOUT	$V_{IN} = 3.9 \text{ V to } 10 \text{ V}, I_{OUT} = 0 \text{ to } 800 \text{ mA}$	TLV1117-25	2.450	2.500	2.550	V	
	$V_{IN} = 4.85 \text{ V}, I_{OUT} = 10 \text{ mA}, T_{J} = 25^{\circ}\text{C}$		2.820	2.850	2.880		
	V _{IN} = 4.25 V to 10 V, I _{OUT} = 0 to 800 mA	TLV1117-285	2.790	2.850	2.910		
	V _{IN} = 4.1 V, I _{OUT} = 0 to 500 mA		2.790	2.850	2.910		
	V _{IN} = 5 V, I _{OUT} = 10 mA, T _J = 25°C		3.267	3.300	3.333		
	V _{IN} = 4.75 V to 10 V, I _{OUT} = 0 to 800 mA	TLV1117-33	3.235	3.300	3.365		
	$V_{IN} = 7 \text{ V, } I_{OUT} = 10 \text{ mA, } T_J = 25^{\circ}\text{C}$	TIV/4447 50	4.950	5.000	5.050		
	$V_{IN} = 6.5 \text{ V to } 12 \text{ V}, I_{OUT} = 0 \text{ to } 800 \text{ mA}$	TLV1117-50	4.900	5.000	5.100		
	$I_{OUT} = 10 \text{ mA}, V_{IN} - V_{OUT} = 1.5 \text{ V to } 13.75 \text{ V}$	TLV1117		0.035	0.2	%	
	I _{OUT} = 0 mA, V _{IN} = 2.9 V to 10 V	TLV1117-15		1	6		
	$I_{OUT} = 0$ mA, $V_{IN} = 3.2$ V to 10 V	TLV1117-18		1	1.270 1.515 1.530 1.818 1.836 2.525 2.550 2.880 2.910 2.910 3.333 3.365 5.050 5.100 0.2 6 6 6 6 10 0.4 10 10 10 10 10 10 11 10 11 120 1.25 1.3 1.5 5		
Line regulation	$I_{OUT} = 0$ mA, $V_{IN} = 3.9$ V to 10 V	TLV1117-25		1	6		
	$I_{OUT} = 0$ mA, $V_{IN} = 4.25$ V to 10 V	TLV1117-285		1	6	6 mV	
	$I_{OUT} = 0$ mA, $V_{IN} = 4.75$ V to 15 V	TLV1117-33		1	6		
	$I_{OUT} = 0$ mA, $V_{IN} = 6.5$ V to 15 V	TLV1117-50		1	10		
	$I_{OUT} = 10$ mA to 800 mA, $V_{IN} - V_{OUT} = 3$ V	TLV1117		0.2	0.4	%	
	$I_{OUT} = 0$ to 800 mA, $V_{IN} = 2.9 \text{ V}$	TLV1117-15		1	10		
	$I_{OUT} = 0$ to 800 mA, $V_{IN} = 3.2 \text{ V}$	TLV1117-18		1	10		
Load regulation	$I_{OUT} = 0$ to 800 mA, $V_{IN} = 3.9$ V	TLV1117-25		1	10		
	$I_{OUT} = 0$ to 800 mA, $V_{IN} = 4.25 \text{ V}$	TLV1117-285		1	10	mV	
	$I_{OUT} = 0$ to 800 mA, $V_{IN} = 4.75 \text{ V}$	TLV1117-33		1	10		
	$I_{OUT} = 0$ to 800 mA, $V_{IN} = 6.5 \text{ V}$	TLV1117-50		1	15		
	I _{OUT} = 100 mA			1.1	1.20		
Dropout voltage, V _{DO} (see Note 2)	I _{OUT} = 500 mA			1.15	1.25	V	
(000 11010 =)	I _{OUT} = 800 mA			1.2	1.3		
Current limit	$V_{IN} - V_{OUT} = 5 \text{ V}, T_J = 25^{\circ}\text{C}$		0.8	1.2	1.5	Α	
Minimum load current	$V_{IN} = 15 \text{ V}$	TLV1117		1.7	5	mA	
Quiescent current	V _{IN} ≤ 15 V	All fixed voltage options		5	10	mA	
Thermal regulation	30 ms pulse,	T _A = 25°C		0.01	0.1	%/W	
Ripple rejection	$V_{IN} - V_{OUT} = 3 \text{ V}, V_{ripple} = 1 V_{pp}$	f = 120 Hz	60	78		dB	

[†] All characteristics are measured with a 10-μF capacitor across the input and a 10-μF capacitor across the output. Pulse testing techniques are used to maintain the junction temperature as close to the ambient temperature as possible.



NOTE 2: Dropout is defined as the V_{IN} to V_{OUT} differential at which V_{OUT} drops 100 mV below the value of V_{OUT} , measured at $V_{IN} = V_{OUT(nom)} + 1.5 \text{ V}$.

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TLV1117C electrical characteristics, T_J = 0°C to 125°C, all typical values are at T_J = 25°C (unless otherwise noted) (continued)

PARAMETER	TEST CONDITIONS [†]	MIN	TYP	MAX	UNIT
ADJUSTMENT pin current			80	120	μΑ
Change in ADJUSTMENT pin current I _{OUT} = 10 mA to 800 mA, V _{IN} – V _{OUT} = 1.4 V to 10 V			0.2	5	μΑ
Temperature stability	T _J = full range		0.5		%
Long-term stability	1000 hrs, no load $T_A = 125$ °C		0.3		%
Output noise voltage (% of VOUT)	f = 10 Hz to 100 kHz,		0.003		%

[†] All characteristics are measured with a 10-μF capacitor across the input and a 10-μF capacitor across the output. Pulse testing techniques are used to maintain the junction temperature as close to the ambient temperature as possible.

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TLV1117I electrical characteristics, $T_J = -40^{\circ}\text{C}$ to 125°C, all typical values are at $T_J = 25^{\circ}\text{C}$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS†		MIN	TYP	MAX	UNIT
	$V_{IN} - V_{OUT} = 2 \text{ V, } I_{OUT} = 10 \text{ mA, } T_{J} = 25^{\circ}\text{C}$	TI \ /4.4.7	1.238	1.250	1.262	
	$I_{OUT} = 10 \text{ mA to } 800 \text{ mA}, V_{IN} - V_{OUT} = 1.4 \text{ V to } 10 \text{ V}$	TLV1117	1.200	1.250	1.290	
	$V_{IN} = 3.5 \text{ V}, I_{OUT} = 10 \text{ mA}, T_{J} = 25^{\circ}\text{C}$	TIV/4447.45	1.485	1.500	1.515	
	V _{IN} = 2.9 V to 10 V, I _{OUT} = 0 to 800 mA	TLV1117-15	1.440	1.500	1.560	
	$V_{IN} = 3.8 \text{ V}, I_{OUT} = 10 \text{ mA}, T_{J} = 25^{\circ}\text{C}$	TI \ /4447 40	1.782	1.800	1.818	
	V _{IN} = 3.2 V to 10 V, I _{OUT} = 0 to 800 mA	TLV1117-18	1.728	1.800	1.872	
Outside only and M	$V_{IN} = 4.5 \text{ V}, I_{OUT} = 10 \text{ mA}, T_J = 25^{\circ}\text{C}$	TI \ /4447 OF	2.475	2.500	2.525	.,
Output voltage, VOUT	$V_{IN} = 3.9 \text{ V to } 10 \text{ V}, I_{OUT} = 0 \text{ to } 800 \text{ mA}$	TLV1117-25	2.400	2.500	2.600	V
	$V_{IN} = 4.85 \text{ V}, I_{OUT} = 10 \text{ mA}, T_{J} = 25^{\circ}\text{C}$	TI \ /4447 005	2.820	2.850	2.880	
	V _{IN} = 4.25 V to 10 V, I _{OUT} = 0 to 800 mA	TLV1117-285	2.736	2.850	2.964	
	V _{IN} = 5 V, I _{OUT} = 10 mA, T _J = 25°C	TI \ /4447 00	3.267	3.300	3.333	
	V _{IN} = 4.75 V to 10 V, I _{OUT} = 0 to 800 mA	TLV1117-33	3.168	3.300	3.432	
	V _{IN} = 7 V, I _{OUT} = 10 mA, T _J = 25°C	TI \ /4447 F0	4.950	5.000	5.050	
	$V_{IN} = 6.5 \text{ V to } 12 \text{ V, } I_{OUT} = 0 \text{ to } 800 \text{ mA}$	TLV1117-50	4.800	5.000	5.200	
	$I_{OUT} = 10 \text{ mA}, V_{IN} - V_{OUT} = 1.5 \text{ V to } 13.75 \text{ V}$	TLV1117		0.035	0.3	%
	I _{OUT} = 0 mA, V _{IN} = 2.9 V to 10 V	TLV1117-15		1	4.5	
	I _{OUT} = 0 mA, V _{IN} = 3.2 V to 10 V	TLV1117-18		1	5.5	
Line regulation	I _{OUT} = 0 mA, V _{IN} = 3.9 V to 10 V	TLV1117-25		1	7.5	mV
	I _{OUT} = 0 mA, V _{IN} = 4.25 V to 10 V	TLV1117-285		1	8.5	
	I _{OUT} = 0 mA, V _{IN} = 4.75 V to 15 V	TLV1117-33		1	10	
	$I_{OUT} = 0 \text{ mA}, V_{IN} = 6.5 \text{ V to } 15 \text{ V}$	TLV1117-50		1	15	
	$I_{OUT} = 10 \text{ mA to } 800 \text{ mA}, V_{IN} - V_{OUT} = 3 \text{ V}$	TLV1117		0.2	0.5	%
	$I_{OUT} = 0$ to 800 mA, $V_{IN} = 2.9$ V	TLV1117-15		1	7.5	
	$I_{OUT} = 0$ to 800 mA, $V_{IN} = 3.2 \text{ V}$	TLV1117-18		1	9	
Load regulation	$I_{OUT} = 0$ to 800 mA, $V_{IN} = 3.9$ V	TLV1117-25		1	12.5	\/
	$I_{OUT} = 0$ to 800 mA, $V_{IN} = 4.25 \text{ V}$	TLV1117-285		1	14.5	mV
	$I_{OUT} = 0$ to 800 mA, $V_{IN} = 4.75 \text{ V}$	TLV1117-33		1	15	
	$I_{OUT} = 0$ to 800 mA, $V_{IN} = 6.5 \text{ V}$	TLV1117-50		1	20	
	I _{OUT} = 100 mA			1.10	1.30	
Dropout voltage, V _{DO} (see Note 2)	I _{OUT} = 500 mA			1.15	1.35	V
(000 11010 2)	IOUT = 800 mA			1.20	1.40	
Current limit	$V_{IN} - V_{OUT} = 5 \text{ V}, T_J = 25^{\circ}\text{C}$		0.8	1.2	1.5	Α
Minimum load current	V _{IN} = 15 V	TLV1117		1.7	5	mA
Quiescent current	V _{IN} ≤ 15 V	All fixed- voltage options		5	15	mA
Thermal regulation	30-ms pulse,	T _A = 25°C		0.01	0.1	%/W
Ripple rejection	$V_{IN} - V_{OUT} = 3 \text{ V}, V_{ripple} = 1 V_{pp}$	f = 120 Hz	60	75		dB

[†] All characteristics are measured with a 10-μF capacitor across the input and a 10-μF capacitor across the output. Pulse testing techniques are used to maintain the junction temperature as close to the ambient temperature as possible.



NOTE 2: Dropout is defined as the V_{IN} to V_{OUT} differential at which V_{OUT} drops 100 mV below the value of V_{OUT} , measured at $V_{IN} = V_{OUT(nom)} + 1.5 \text{ V}$.

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TLV1117I electrical characteristics, $T_J = 40^{\circ}C$ to $125^{\circ}C$, all typical values are at $T_J = 25^{\circ}C$ (unless otherwise noted) (continued)

PARAMETER	TEST CONDITIONS†	MIN	TYP	MAX	UNIT
ADJUSTMENT pin current			80	120	μΑ
Change in ADJUSTMENT pin current	$I_{OUT} = 10 \text{ mA to } 800 \text{ mA}, V_{IN} - V_{OUT} = 1.4 \text{ V to } 10 \text{ V}$		0.2	10	μΑ
Temperature stability	T _J = full range		0.5		%
Long-term stability	1000 hrs, no load $T_A = 125$ °C		0.3		%
Output noise voltage (% of VOUT)	f = 10 Hz to 100 kHz,		0.003		%

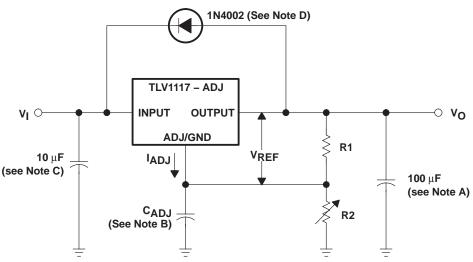
[†] All characteristics are measured with a 10-μF capacitor across the input and a 10-μF capacitor across the output. Pulse testing techniques are used to maintain the junction temperature as close to the ambient temperature as possible.

GRAPHS (PREVIEW):

- Figure 1. Short-Circuit Current vs (V_{IN}-V_{OUT})
- Figure 2. Load Regulation vs Temperature
- Figure 3. Ripple Rejection vs Frequency (ADJ Version)
- Figure 4. Ripple Rejection vs Current (ADJ Version)
- Figure 5. Temperature Stability
- Figure 6. ADJ Pin Current vs Temperature
- Figure 7. TLV1117-25 Load Transient Response
- Figure 8. TLV1117-25 Line Transient Response
- Figure 9. TLV1117-285 Load Transient Response
- Figure 10. TLV1117-285 Line Transient Response
- Figure 11. TLV1117-33 Load Transient Response
- Figure 12. TLV1117-33 Line Transient Response



APPLICATION INFORMATION



V_{OUT} is calculated as:

$$V_{OUT} = V_{REF} \left(1 + \frac{R2}{R1} \right) + (I_{ADJ} \times R2)$$

Since $I_{AD,I}$ typically is 55 μ A, it is negligible in most applications.

- NOTES: A. Output capacitor selection is critical for regulator stability. The recommended minimum is $10-\mu F$ tantalum or $50-\mu F$ aluminum electrolytic, with either one having an ESR between $0.3~\Omega$ and $22~\Omega$. Larger C_{OUT} values benefit the regulator by improving transient response and loop stability.
 - B. C_{ADJ} can be used to improve ripple rejection. Ensure that the impedance of C_{ADJ} $\left(X_{CADJ} = \frac{1}{2\pi f_{ripple}C_{ADJ}}\right)$ is < R1 to prevent the ripple from being amplified. If C_{ADJ} is used, then a larger C_{OUT} is required (22-µF tantalum or 150-µF aluminum electrolytic).
 - C. CIN is recommended if TLV1117 is not located near the power-supply filter.
 - D. An external diode is recommended to protect the regulator if the input instantaneously is shorted to GND.

Figure 13. Basic Adjustable Regulator



PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
TLV1117-15CDCY	PREVIEW	SOT-223	DCY	4	80	None	Call TI	Call TI
TLV1117-15CDCYR	PREVIEW	SOT-223	DCY	4	2500	None	Call TI	Call TI
TLV1117-15CKCS	PREVIEW	TO-220	KCS	3	50	None	Call TI	Call TI
TLV1117-15IDCY	PREVIEW	SOT-223	DCY	4	80	None	Call TI	Call TI
TLV1117-15IDCYR	PREVIEW	SOT-223	DCY	4	2500	None	Call TI	Call TI
TLV1117-15IKCS	PREVIEW	TO-220	KCS	3	50	None	Call TI	Call TI
TLV1117-18CDCY	PREVIEW	SOT-223	DCY	4	80	None	Call TI	Call TI
TLV1117-18CDCYR	PREVIEW	SOT-223	DCY	4	2500	None	Call TI	Call TI
TLV1117-18CKCS	PREVIEW	TO-220	KCS	3	50	None	Call TI	Call TI
TLV1117-18IDCY	PREVIEW	SOT-223	DCY	4	80	None	Call TI	Call TI
TLV1117-18IDCYR	PREVIEW	SOT-223	DCY	4	2500	None	Call TI	Call TI
TLV1117-18IKCS	PREVIEW	TO-220	KCS	3	50	None	Call TI	Call TI
TLV1117-25CKTPR	PREVIEW	PFM	KTP	2	3000	None	Call TI	Call TI
TLV1117-33CDCY	PREVIEW	SOT-223	DCY	4	80	None	Call TI	Call TI
TLV1117-33CDCYR	PREVIEW	SOT-223	DCY	4	2500	None	Call TI	Call TI
TLV1117-33CKC	PREVIEW	TO-220	KC	3	50	None	Call TI	Call TI
TLV1117-33CKCS	PREVIEW	TO-220	KCS	3	50	None	Call TI	Call TI
TLV1117-33CKTT	PREVIEW	DDPAK/ TO-263	KTT	3	50	None	Call TI	Call TI
TLV1117-33CKTTR	PREVIEW	DDPAK/ TO-263	KTT	3	1000	None	Call TI	Call TI
TLV1117-33DCY	PREVIEW	SOT-223	DCY	4	80	None	Call TI	Call TI
TLV1117-33IKCS	PREVIEW	TO-220	KCS	3	50	None	Call TI	Call TI
TLV1117-50CDCY	PREVIEW	SOT-223	DCY	4	80	None	Call TI	Call TI
TLV1117-50CKCS	PREVIEW	TO-220	KCS	3	50	None	Call TI	Call TI
TLV1117-50CKTER	PREVIEW	PFM	KTE	3	2000	None	Call TI	Call TI
TLV1117-50CKTPR	PREVIEW	PFM	KTP	2	3000	None	Call TI	Call TI
TLV1117-50CKTT	PREVIEW	DDPAK/ TO-263	KTT	3	50	None	Call TI	Call TI
TLV1117-50CKTTR	PREVIEW	DDPAK/ TO-263	KTT	3		None	Call TI	Call TI
TLV1117-50DCYR	PREVIEW	SOT-223	DCY	4	2500	None	Call TI	Call TI
TLV1117CDCY	ACTIVE	SOT-223	DCY	4	80	None	CU	Level-2-235C-1 YEAR
TLV1117CDCYR	ACTIVE	SOT-223	DCY	4	2500	None	CU	Level-2-235C-1 YEAR
TLV1117CKC	PREVIEW	TO-220	KC	3	50	None	Call TI	Call TI
TLV1117CKCS	ACTIVE	TO-220	KCS	3	50	None	Call TI	Level-NC-NC-NC
TLV1117CKTER	ACTIVE	PFM	KTE	3	2000	None	Call TI	Level-1-220C-UNLIM
TLV1117CKTPR	ACTIVE	PFM	KTP	2	3000	None	Call TI	Level-1-220C-UNLIM
TLV1117IDCY	ACTIVE	SOT-223	DCY	4	80	None	CU	Level-2-235C-1 YEAR
TLV1117IDCYR	ACTIVE	SOT-223	DCY	4	2500	None	CU	Level-2-235C-1 YEAR
TLV1117IKCS	ACTIVE	TO-220	KCS	3	50	None	Call TI	Level-NC-NC-NC
TLV1117IKTER	ACTIVE	PFM	KTE	3	2000	None	Call TI	Level-1-220C-UNLIM
TLV1117IKTPR	ACTIVE	PFM	KTP	2	3000	None	Call TI	Level-1-220C-UNLIM



PACKAGE OPTION ADDENDUM

21-Feb-2005

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - May not be currently available - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

None: Not yet available Lead (Pb-Free).

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDECindustry standard classifications, and peak solder temperature.

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DCY (R-PDSO-G4)

PLASTIC SMALL-OUTLINE



NOTES: A. All linear dimensions are in millimeters (inches).

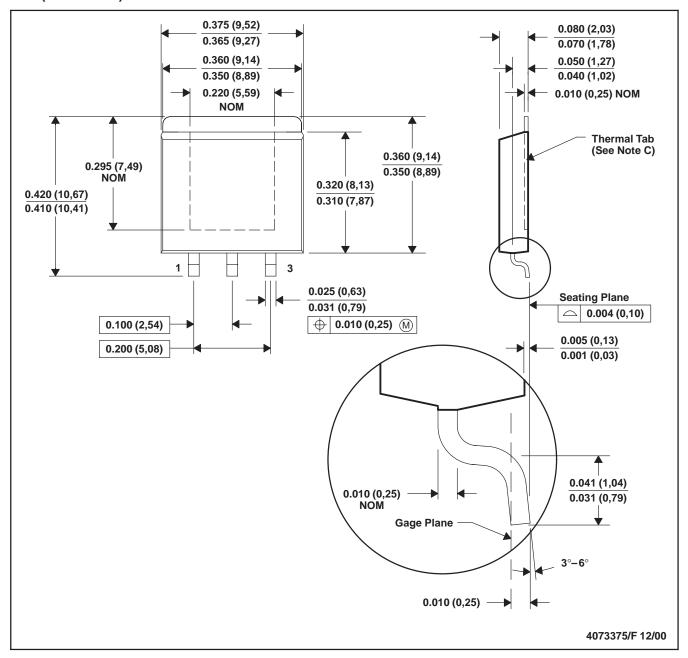
B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion.

D. Falls within JEDEC TO-261 Variation AA.

KTE (R-PSFM-G3)

PowerFLEX™ PLASTIC FLANGE-MOUNT



NOTES: A. All linear dimensions are in inches (millimeters).

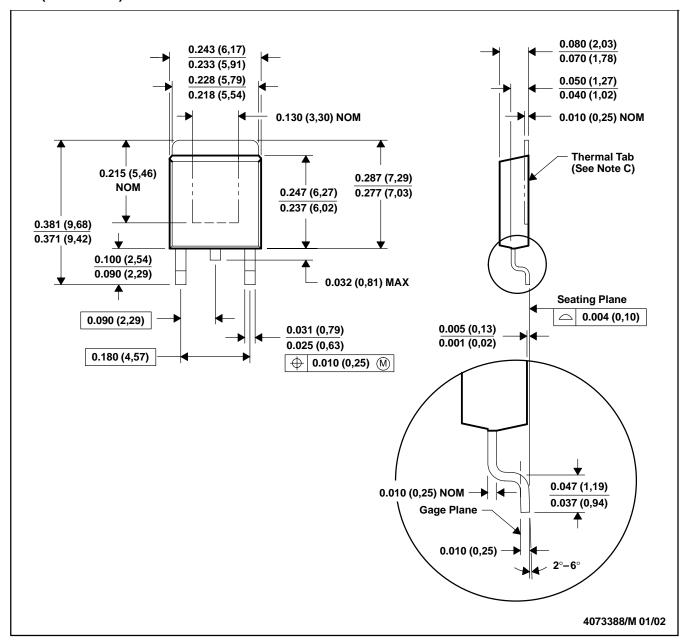
- B. This drawing is subject to change without notice.
- C. The center lead is in electrical contact with the thermal tab.
- D. Dimensions do not include mold protrusions, not to exceed 0.006 (0,15).
- E. Falls within JEDEC MO-169

PowerFLEX is a trademark of Texas Instruments.



KTP (R-PSFM-G2)

PowerFLEX™ PLASTIC FLANGE-MOUNT PACKAGE



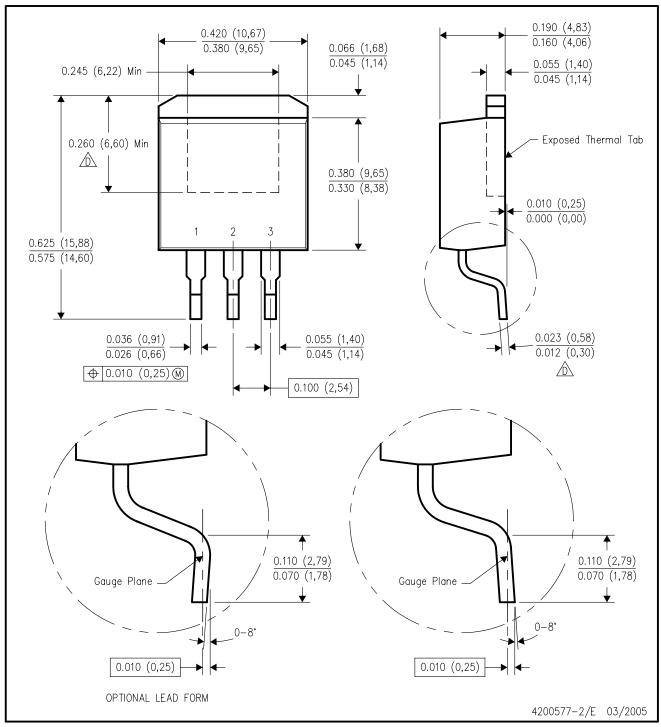
- NOTES: A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. The center lead is in electrical contact with the thermal tab.
 - D. Dimensions do not include mold protrusions, not to exceed 0.006 (0,15).
 - E. Falls within JEDEC TO-252 variation AC.

PowerFLEX is a trademark of Texas Instruments.



KTT (R-PSFM-G3)

PLASTIC FLANGE-MOUNT PACKAGE



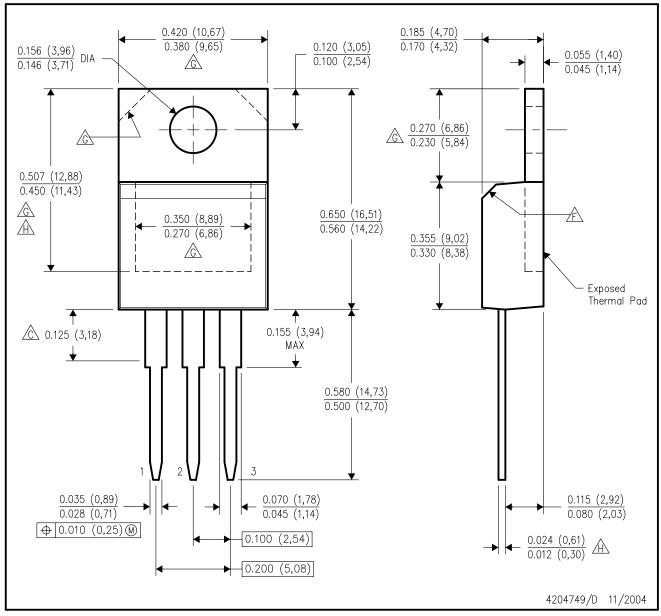
NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion. Mold flash or protrusion not to exceed 0.005 (0,13) per side.
- ∱ Falls within JEDEC TO-263 variation AA, except minimum lead thickness and minimum exposed pad length.



KCS (R-PSFM-T3)

PLASTIC FLANGE-MOUNT PACKAGE



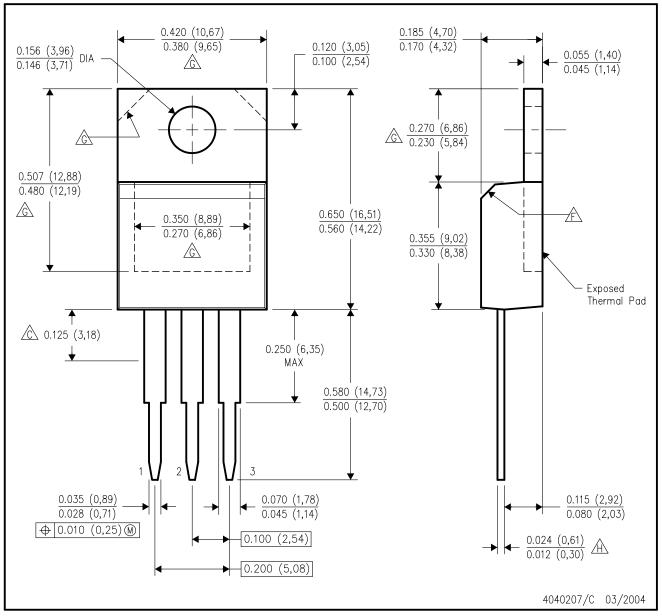
NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Lead dimensions are not controlled within this area.
- D. All lead dimensions apply before solder dip.
- E. The center lead is in electrical contact with the mounting tab.
- The chamfer is optional.
- Thermal pad contour optional within these dimensions.
- Falls within JEDEC T0—220 variation AB, except minimum lead thickness and minimum exposed pad length.



KC (R-PSFM-T3)

PLASTIC FLANGE-MOUNT PACKAGE



NOTES: A

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Lead dimensions are not controlled within this area.
- D. All lead dimensions apply before solder dip.
- E. The center lead is in electrical contact with the mounting tab.
- The chamfer is optional.
- Thermal pad contour optional within these dimensions.
- Falls within JEDEC TO-220 variation AB, except minimum lead thickness.



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